

	Type	Hits	Search Text	DBs
1	ESP	5114	multilevels multi-levels multidimensions multidimensional multilayers4 multi-layers4 substrates same channels waveguides wave ad1 guides wave-guides openings vias vertical ad1 cavities vessel	USPAT
2	ESP	2573	multilevels multi-levels multidimensions multidimensional multilayers4 multi-layers4 substrates same channels openings cavities waveguides wave ad1 guides wave-guides openings vias vertical ad1 cavities vessel	USPAT
3	ESP	1553	multilevels multi-levels multidimensions multidimensional multilayers4 multi-layers4 substrates same vias	USPAT
4	ESP	1381	substrates same vias	USPAT
5	ESP	1381	multilevels multi-levels multidimensions multidimensional multilayers4 multi-layers4 substrates same vias and substrates same vias	USPAT
6	ESP	433170	insertion deposits grooves same materials1	USPAT
7	ESP	134177	etches	USPAT
8	ESP	343032	substrates same substrates layers2	USPAT
9	ESP	15545	waveguides wave ad1 guides wave-guides	USPAT
10	ESP	15545	clashes	USPAT
11	ESP	240287	inserts high ad1 circuit1 vertical ad1 cavities and cavities vessel	USPAT
12	ESP	2	substrates same vias and etches and conducts same substrates layers2 and waveguides wave ad1 guides wave-guides and clashes and inserts deposits grooves and materials1	USPAT
13	ESP	4	substrates same vias and etches and conducts same substrates layers2 and waveguides wave ad1 guides wave-guides and clashes and materials1	USPAT
14	ESP	1	substrates same vias and inserts deposits grooves same materials1 and etches and conducts same substrates layers2 and waveguides wave ad1 guides wave-guides and clashes	USPAT
15	ESP	4	multilevels multi-levels multidimensions multidimensional multilayers4 multi-layers4 substrates same vias and substrates same vias and materials1 and etches and conducts same substrates layers2 and waveguides wave ad1 guides wave-guides and clashes and inserts high ad1 circuit1 vertical ad1 cavities vessel	USPAT
16	ESP	447	substrates same channels openings vias vertical ad1 cavities vessel	USPAT
17	ESP	14	substrates same channels openings vias vertical ad1 cavities vessel ad1 circuit1 circuit1 n w2 wave materials1 materials1 and materials1 substrates layers2 and waveguides wave ad1 guides wave-guides and clashes	USPAT

	Time Stamp	Co mm en ts	Er ro r De fi ni ti on	Er ro rs
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	Type	Hits	Search Text	DBs
15	PPF	1	substrates same channels openings via cavities holes vertical and cavities vessel and inserted deposited grows same material and etches and conductive same substrates layers and waveguides wave and guides wave guides and clads	US P3 EUP EIP JIP GERWE NT
16	HKS	10	substrates same channels openings via cavities holes vertical and cavities vessel and inserted deposited grows and material and etches and conductive same substrates layers and waveguides wave and guides wave guides and clads	USPAT EIP JIP
2	HKS	6	substrates same channels openings via cavities holes vertical and cavities vessel and inserted deposited grows and material and etches and conductive same substrates layers and waveguides wave and guides wave guides and clads	USPAT
11	PPF	11	substrates same channels openings via cavities holes vertical and cavities vessel and inserted deposited grows same material and etches and conductive same substrates layers and waveguides wave and guides wave guides and clads	USPAT
11	HKS	4	substrates same via and conductive and waveguides wave and guides wave guides and clads and materials	USPAT
11	PPF	10	substrates same channels openings via cavities holes vertical and cavities vessel and inserted deposited grows and material and etches and conductive same substrates layers and waveguides wave and guides wave guides and clads	USPAT
14	PPF	7	substrates same channels openings via cavities holes vertical and cavities vessel and inserted deposited grows and material and etches and conductive same substrates layers and waveguides wave and guides wave guides and clads	USPAT
14	PPF	7	substrates same channels openings via cavities holes vertical and cavities vessel and inserted deposited grows same material and etches and conductive same substrates layers and waveguides wave and guides wave guides and clads	USPAT
14	PPF	7	substrates same channels openings via cavities holes vertical and cavities vessel and inserted deposited grows and material and etches and conductive same substrates layers and waveguides wave and guides wave guides and clads	USPAT

	Time Stamp	Co mm en ts	Er ro r De fi ni ti on	Er ro rs
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	Type	Hits	Search Text	DBs
12	BBF	4	<p>substrates same channels openings via cavities holes vertical and cavity vessel and inserts deposited growth and materials and conductive same</p> <p>substrates layers2 and waveguides wave-dip guides wave-guides and clads not</p> <p>substrates same channels openings via cavities holes vertical and cavity vessel and inserts deposited growth and materials and conductive and conductive same</p> <p>substrates layers2 and waveguides wave-dip guides wave-guides and clads</p> <p>substrates same via and conductive same</p> <p>substrates layers2 and waveguides wave-dip guides wave-guides and clads and materials</p> <p>substrates same channels openings via cavities holes vertical and cavity vessel and inserts deposited growth and materials and conductive and conductive same</p> <p>substrates layers2 and waveguides wave-dip guides wave-guides and clads</p>	USPAT
13	BBF	4	<p>substrates same via and conductive same</p> <p>substrates layers2 and waveguides wave-dip guides wave-guides and clads and materials</p>	USPAT
14	BBF	7	<p>substrates same channels openings via cavities holes vertical and cavity vessel and inserts deposited growth and materials and conductive and conductive same</p> <p>substrates layers2 and waveguides wave-dip guides wave-guides and clads</p>	USPAT
15	BBF	10	<p>substrates same channels openings via cavities holes vertical and cavity vessel and inserts deposited growth and materials and conductive and conductive same</p> <p>substrates layers2 and waveguides wave-dip guides wave-guides and clads</p> <p>substrates same channels openings via cavities holes vertical and cavity vessel and inserts deposited growth and materials and conductive and conductive same</p> <p>substrates layers2 and waveguides wave-dip guides wave-guides and clads</p>	USPAT

	Time Stamp	Com men ts	Er ro r De fi ni ti on	Er ro rs

	Type	Hits	Search Text	DBs
1	P	11	<p>substrates same channels openings via cavities holes vertical and cavities vessel and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave and guides wave guides and clads and substrates same channels openings via cavities holes vertical and cavities vessel and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave and guides wave guides and clads</p> <p>substrates same channels openings via cavities holes vertical and cavities vessel and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave and guides wave guides and clads</p> <p>substrates same channels openings via cavities holes vertical and cavities vessel and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave and guides wave guides and clads</p> <p>substrates same channels openings via cavities holes vertical and cavities vessel and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave and guides wave guides and clads</p> <p>substrates same channels openings via cavities holes vertical and cavities vessel and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave and guides wave guides and clads</p> <p>substrates same channels openings via cavities holes vertical and cavities vessel and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave and guides wave guides and clads</p> <p>substrates same channels openings via cavities holes vertical and cavities vessel and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave and guides wave guides and clads</p> <p>substrates same channels openings via cavities holes vertical and cavities vessel and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave and guides wave guides and clads</p> <p>substrates same channels openings via cavities holes vertical and cavities vessel and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave and guides wave guides and clads</p> <p>substrates same channels openings via cavities holes vertical and cavities vessel and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave and guides wave guides and clads</p>	STAT

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	Type	Hits	Search Text	DBs
41	BBA		<p>substrates same channels openings vias cavities holes vertical drill cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave drill guides wave guides and clades and substrates same channels openings via cavities holes vertical drill cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave drill guides wave guides and clades and substrates same channels openings via cavities holes vertical drill cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave drill guides wave guides and clades and materials substrates same channels openings via cavities holes vertical drill cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and</p>	USIA

	Type	Hits	Search Text	DBs
12	BBB	11	<p>substrates same channels openings vias cavities holes vertical vias cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave vias guides wave guides and clads and substrates same channels openings vias cavities holes vertical vias cavities vias and inserts deposited grows and materials and clads and conductors same substrates layers and waveguides wave vias guides wave guides and clads and substrates same channels openings vias cavities holes vertical vias cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave vias guides wave guides and clads and materials substrates same channels openings vias cavities holes vertical vias cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave vias guides wave guides and clads and materials</p>	TSIAI
13	BBB	1	<p>substrates same channels openings vias cavities holes vertical vias cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave vias guides wave guides and clads and materials</p>	TSIAI
14	BBB	1	<p>substrates same channels openings vias cavities holes vertical vias cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave vias guides wave guides and clads and materials</p>	TSIAI
15	BBB	1	<p>substrates same channels openings vias cavities holes vertical vias cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave vias guides wave guides and clads and materials</p>	TSIAI
16	BBB	1	<p>substrates same channels openings vias cavities holes vertical vias cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave vias guides wave guides and clads and materials</p>	TSIAI
17	BBB	1	<p>substrates same channels openings vias cavities holes vertical vias cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave vias guides wave guides and clads and materials</p>	TSIAI
18	BBB	1	<p>substrates same channels openings vias cavities holes vertical vias cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave vias guides wave guides and clads and materials</p>	TSIAI
19	BBB	1	<p>substrates same channels openings vias cavities holes vertical vias cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave vias guides wave guides and clads and materials</p>	TSIAI
20	BBB	1	<p>substrates same channels openings vias cavities holes vertical vias cavities vias and inserts deposited grows and materials and etches and conductors same substrates layers and waveguides wave vias guides wave guides and clads and materials</p>	TSIAI

	Time Stamp	Comments	Errors
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207	2002/10/23 16:05		0
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42	RRF	1	6432-1.1.1.1. and 6432-1.1.1.2. channels waveguide glassed insert4 fibered waveguide glassed insert4 fibered filler transparent glass	USIA
43	RRF	1	6432-1.1.1.1. and 6432-1.1.1.2. channels waveguide glassed insert4 fibered filler transparent glass	USIA
44	RRF	1	6432-1.1.1.1. and 6432-1.1.1.2. channels waveguide glassed insert4 fibered filler transparent glass	USIA
45	RRF	1	6432-1.1.1.1. and 6432-1.1.1.2. channels waveguide glassed insert4 fibered filler transparent glass	USIA
46	RRF	1	6432-1.1.1.1. and 6432-1.1.1.2. channels waveguide glassed insert4 fibered filler transparent glass	USIA
47	RRF	1	6432-1.1.1.1. and 6432-1.1.1.2. channels waveguide glassed insert4 fibered filler transparent glass	USIA
48	RRF	1	6432-1.1.1.1. and 6432-1.1.1.2. channels waveguide glassed insert4 fibered filler transparent glass	USIA
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	Time Stamp	Co mm en ts	Er ro r De fi ni ti on	Er ro rs
41	2001.12.17 16:11			
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46	2001.12.17 18:10			
47	2001.12.17 18:17			
48	2001.12.17 18:44			
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59	2001.12.18 10:48			
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